



**THE DATASHEET OF  
GW CSHPM1.CM-KTLP-XX57-1-350-R18**



# OSRAM GW CSHPM1.CM

## Datasheet

Published by **ams-OSRAM AG**

Tobelbader Strasse 30, 8141 Premstaetten, Austria

Phone +43 3136 500-0

[ams-osram.com](http://ams-osram.com)

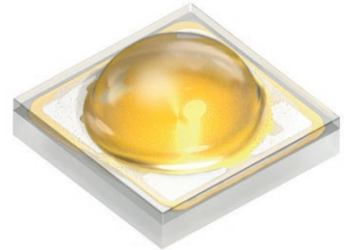
© All rights reserved



OSLON® SSL 150

# GW CSHPM1.CM

Higher performance. Lower thermal resistance. Extended range of driving conditions. This OSLON SSL family new generation LED provides a wide radiation pattern allowing perfect interaction and various designs including color mixing LED clusters.



## Applications

- Entertainment
- Indoor Lighting
- Outdoor & Industrial Lighting

## Features

- Package: SMT ceramic package with silicone lens
- Typ. Radiation: 150°
- Color temperature: 2700K - 4000K
- CRI: 90 (min.), 92 (typ.), R9: 50 (min.)
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Luminous Flux: typ. 105 lm @ 3000 K, 85 °C
- Luminous efficacy: typ. 105 lm/W @ 3000 K, 85 °C

## Ordering Information

Type	Color temperature	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ $\Phi_V$	Ordering Code
GW CSHPM1.CM-KSKU-XX58-1	2700 K	89 ... 112 lm	Q65112A1127
GW CSHPM1.CM-KTLP-XX57-1	3000 K	97 ... 121 lm	Q65112A0958
GW CSHPM1.CM-KTLP-XX56-1	3500 K	97 ... 121 lm	Q65112A1437
GW CSHPM1.CM-KULQ-XX56-1	3500 K	104 ... 130 lm	Q65112A1435
GW CSHPM1.CM-KULQ-XX55-1	4000 K	104 ... 130 lm	Q65112A1115

## Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min.	-40 °C
		max.	125 °C
Storage Temperature	$T_{stg}$	min.	-40 °C
		max.	125 °C
Junction temperature absolute **	$T_{j,abs}$	max.	160 °C
Junction Temperature	$T_j$	max.	135 °C
Forward Current $T_j = 85\text{ °C}$	$I_F$	min.	100 mA
		max.	1300 mA
Surge Current $t \leq 10\ \mu\text{s}; D = 0.005; T_j = 85\text{ °C}$	$I_{FS}$	max.	2000 mA
Reverse current <sup>2)</sup>	$I_R$	max.	200 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV

\*\* This is verified by testing 30 pieces. Pass criteria: No catastrophic failures allowed, luminous flux must be better than L70B50 after 1000 h.

## Characteristics

$I_F = 350 \text{ mA}$ ;  $T_J = 85 \text{ °C}$

Parameter	Symbol		Values
Viewing angle at 50% $I_V$	$2\phi$	typ.	150 °
Forward Voltage <sup>3)</sup> $I_F = 350 \text{ mA}$	$V_F$	min. typ. max.	2.70 V 2.85 V 3.20 V
Reverse voltage <sup>2)</sup> $I_R = 20 \text{ mA}$	$V_R$	max.	1.2 V
Color Rendering Index <sup>4)</sup>	CRI	min. typ.	90 92
Color Rendering Index (R9) <sup>4)</sup>	CRI (R9)	min.	50
Electrical thermal resistance junction/solderpoint with efficiency $\eta_e = 20 \%$	$R_{thJS \text{ elec.}}$	typ.	4.2 K / W

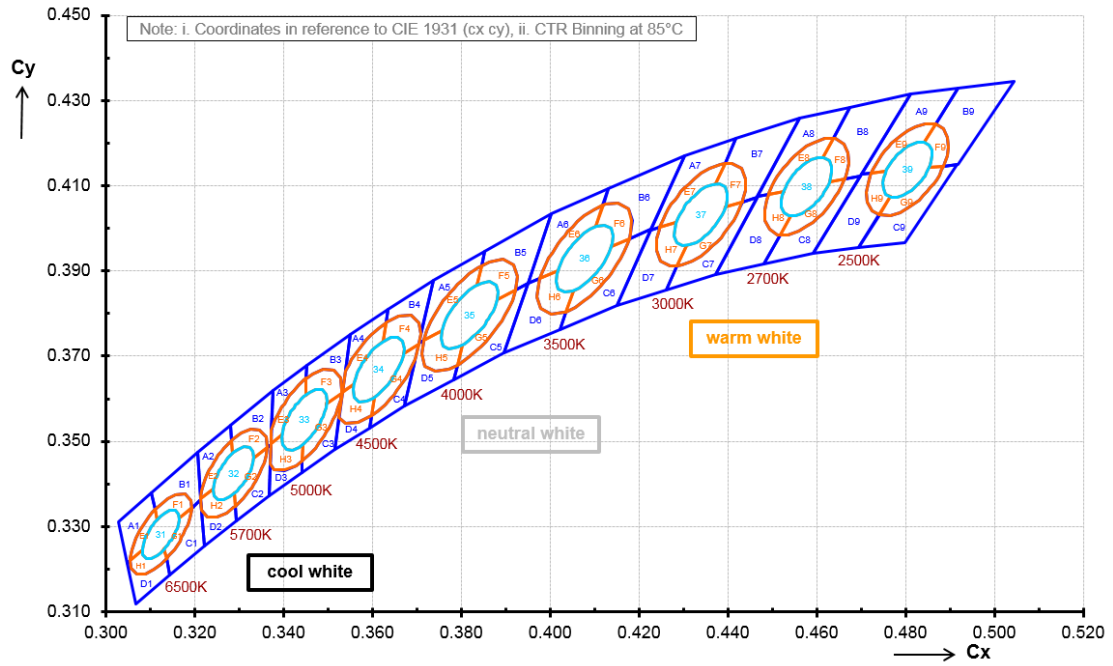
## Brightness Groups

Group	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ max. $\Phi_V$
KS	89 lm	97 lm
KT	97 lm	104 lm
KU	104 lm	112 lm
LP	112 lm	121 lm
LQ	121 lm	130 lm

## Forward Voltage Groups

Group	Forward Voltage <sup>3)</sup> $I_F = 350 \text{ mA}$ min. $V_F$	Forward Voltage <sup>3)</sup> $I_F = 350 \text{ mA}$ max. $V_F$
K2	2.70 V	2.80 V
L1	2.80 V	2.90 V
L2	2.90 V	3.00 V
M1	3.00 V	3.10 V
M2	3.10 V	3.20 V

Chromaticity Coordinate Groups <sup>5)</sup>



## Chromaticity Coordinate Groups

CCT	Center Cx	Center Cy	3step a	3step b	5step a	5step b	∅
2700 K	0.4577	0.4098	0.0080	0.0041	0.0133	0.0068	54.1
3000 K	0.4339	0.4032	0.0086	0.0042	0.0142	0.0069	53.7
3500 K	0.4077	0.3929	0.0093	0.0042	0.0155	0.0069	53.9
4000 K	0.3818	0.3796	0.0094	0.0041	0.0157	0.0068	53.4

CCT	Group	1		2		3		4	
		Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
2700 K	E	0.4637	0.4212	0.4491	0.4081	0.4526	0.4088	0.4613	0.4166
	F	0.4637	0.4212	0.4663	0.4115	0.4628	0.4108	0.4613	0.4166
	G	0.4663	0.4115	0.4517	0.3984	0.4541	0.4030	0.4628	0.4108
	H	0.4541	0.4030	0.4526	0.4088	0.4491	0.4081	0.4517	0.3984
3000 K	E	0.4393	0.4153	0.4246	0.4002	0.4283	0.4014	0.4371	0.4105
	F	0.4393	0.4153	0.4432	0.4062	0.4395	0.4050	0.4371	0.4105
	G	0.4432	0.4062	0.4285	0.3911	0.4307	0.3960	0.4395	0.4050
	H	0.4307	0.3960	0.4283	0.4014	0.4246	0.4002	0.4285	0.3911
3500 K	E	0.4118	0.4054	0.3977	0.3883	0.4017	0.3902	0.4102	0.4004
	F	0.4118	0.4054	0.4177	0.3975	0.4137	0.3956	0.4102	0.4004
	G	0.4177	0.3975	0.4036	0.3804	0.4052	0.3854	0.4137	0.3956
	H	0.4052	0.3854	0.4017	0.3902	0.3977	0.3883	0.4036	0.3804
4000 K	E	0.3845	0.3913	0.3714	0.3737	0.3756	0.3760	0.3834	0.3866
	F	0.3845	0.3913	0.3922	0.3855	0.3880	0.3832	0.3834	0.3866
	G	0.3922	0.3855	0.3791	0.3679	0.3802	0.3726	0.3880	0.3832
	H	0.3802	0.3726	0.3756	0.3760	0.3714	0.3737	0.3791	0.3679

---

## Group Name on Label

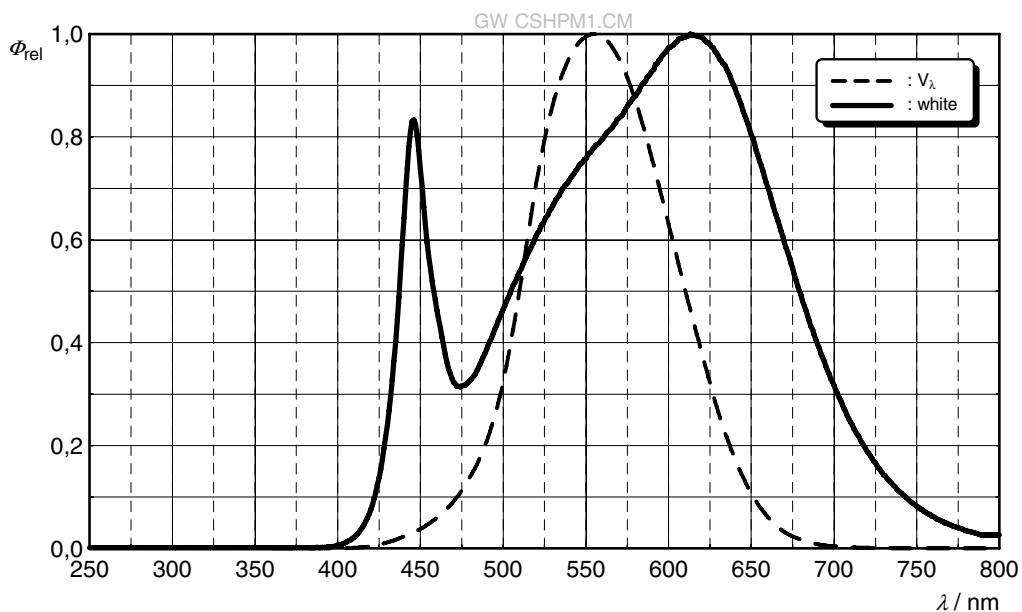
**Example: KS-37-K2**

Brightness	Color Chromaticity	Forward Voltage
KS	37	K2

---

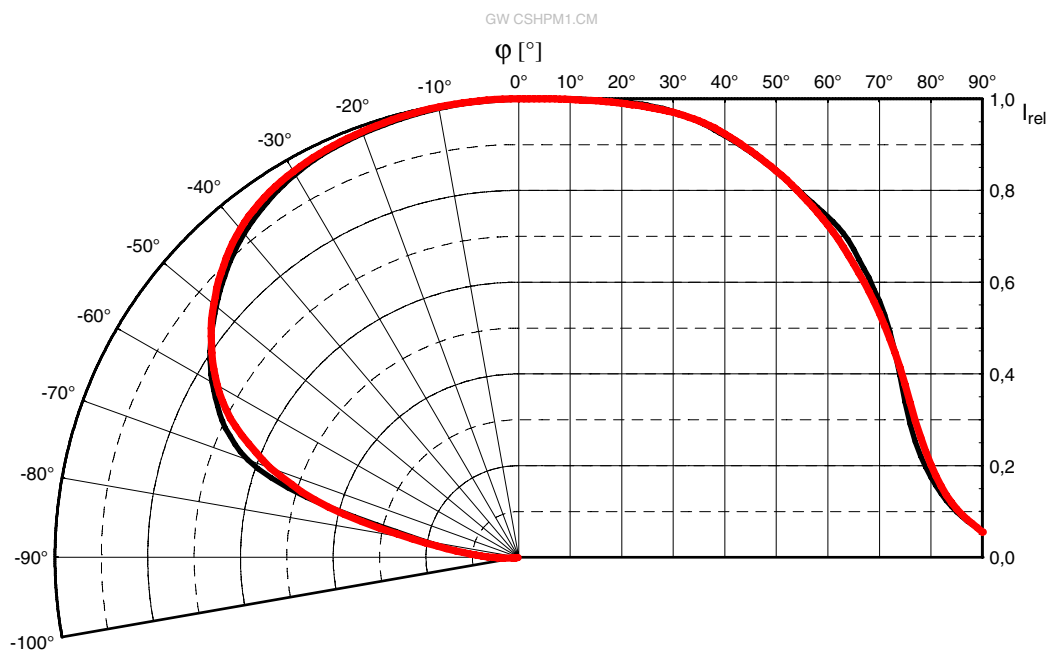
## Relative Spectral Emission <sup>6)</sup>

$$\Phi_{\text{rel}} = f(\lambda); I_F = 350 \text{ mA}; T_J = 85 \text{ }^\circ\text{C}$$



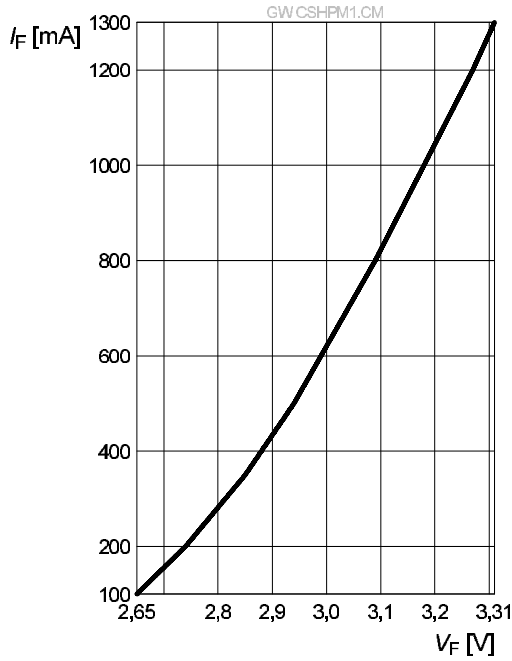
## Radiation Characteristics <sup>6)</sup>

$$I_{\text{rel}} = f(\phi); T_J = 85 \text{ }^\circ\text{C}$$



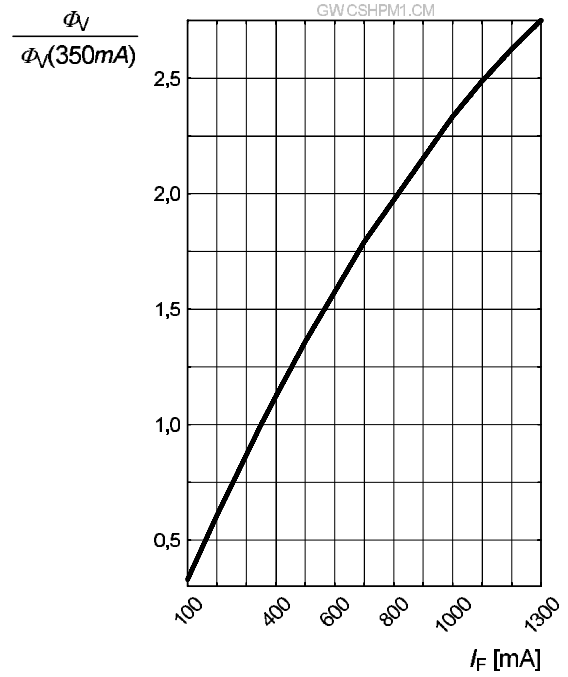
**Forward current** 6), 7)

$I_F = f(V_F); T_J = 85\text{ °C}$



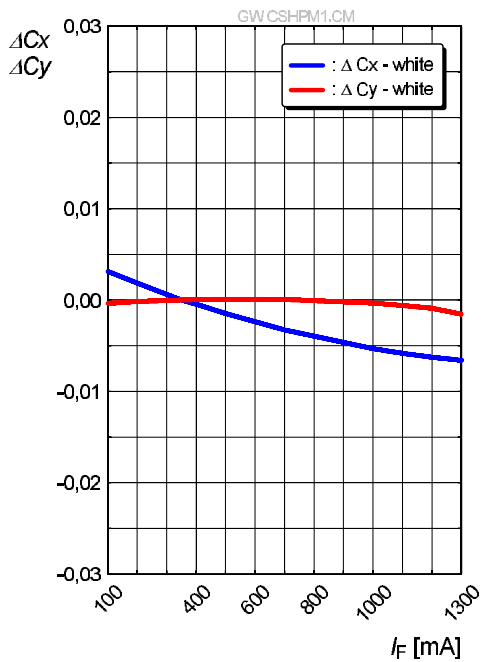
**Relative Luminous Flux** 6), 7)

$\Phi_V / \Phi_V(350\text{ mA}) = f(I_F); T_J = 85\text{ °C}$



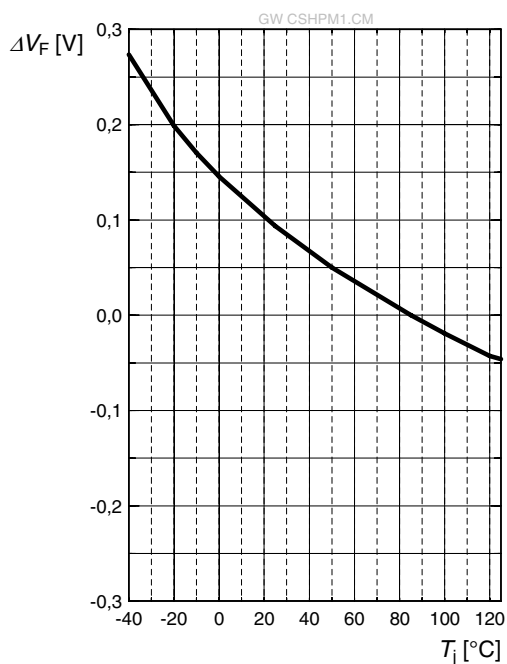
**Chromaticity Coordinate Shift** 6)

$\Delta Cx, \Delta Cy = f(I_F); T_J = 85\text{ °C}$



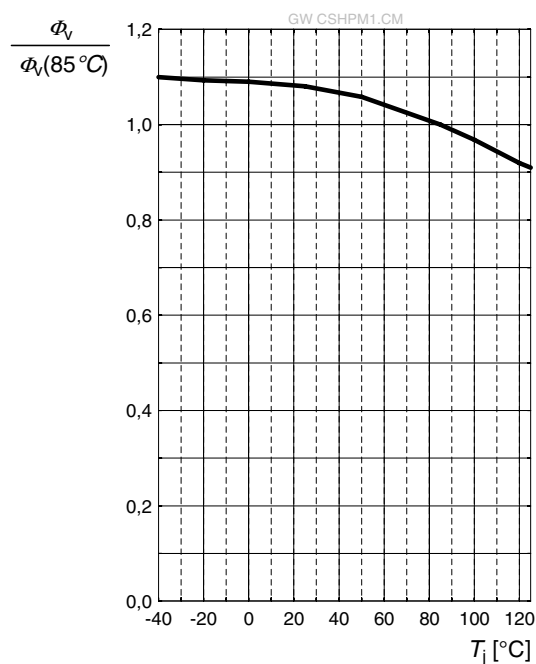
### Forward Voltage <sup>6)</sup>

$$\Delta V_F = V_F - V_F(85^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$



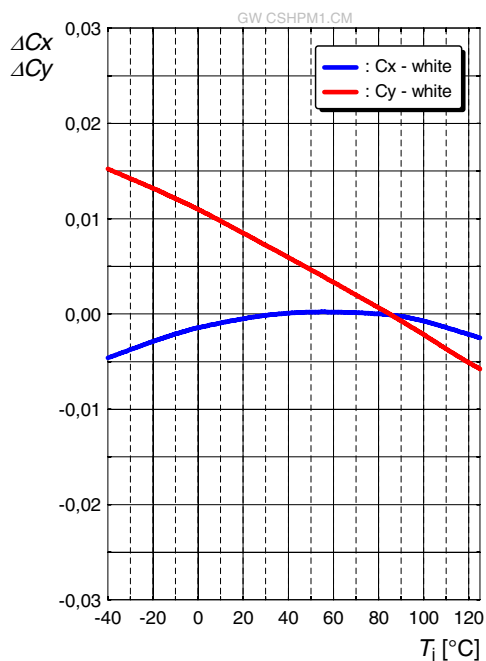
### Relative Luminous Flux <sup>6)</sup>

$$\Phi_V / \Phi_V(85^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$



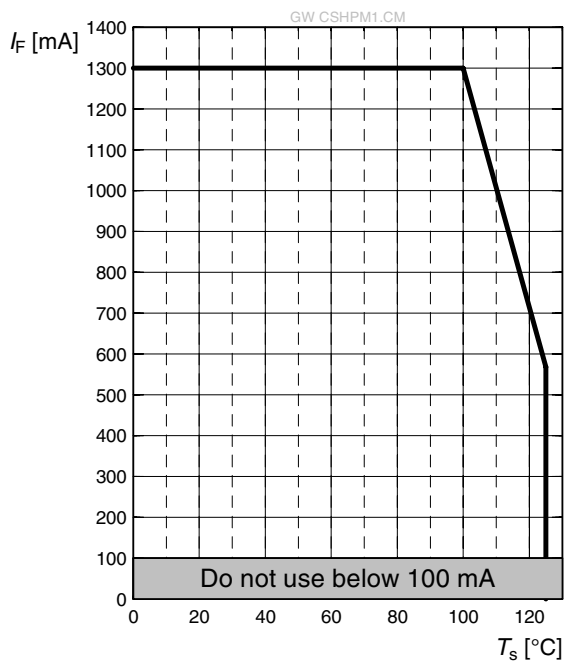
### Chromaticity Coordinate Shift <sup>6)</sup>

$$\Delta C_x, \Delta C_y = f(T_j); I_F = 350\text{ mA}$$

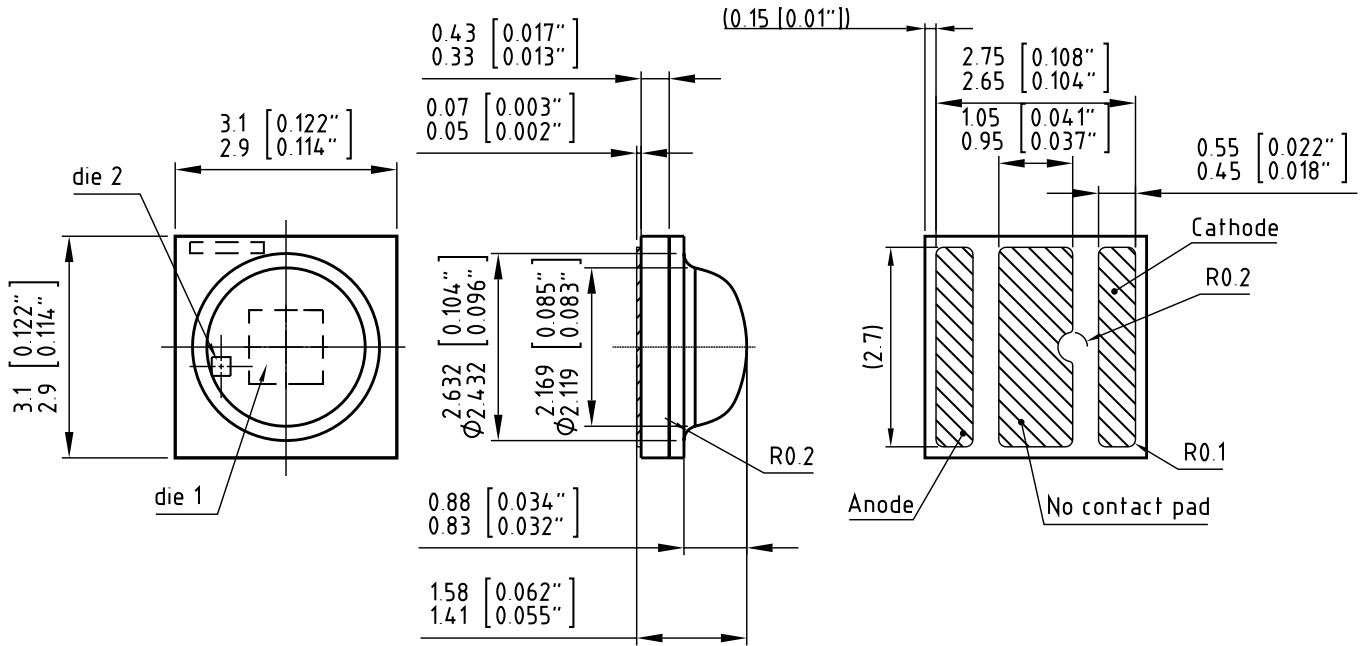


## Max. Permissible Forward Current <sup>8)</sup>

$$I_F = f(T)$$



Dimensional Drawing <sup>9)</sup>



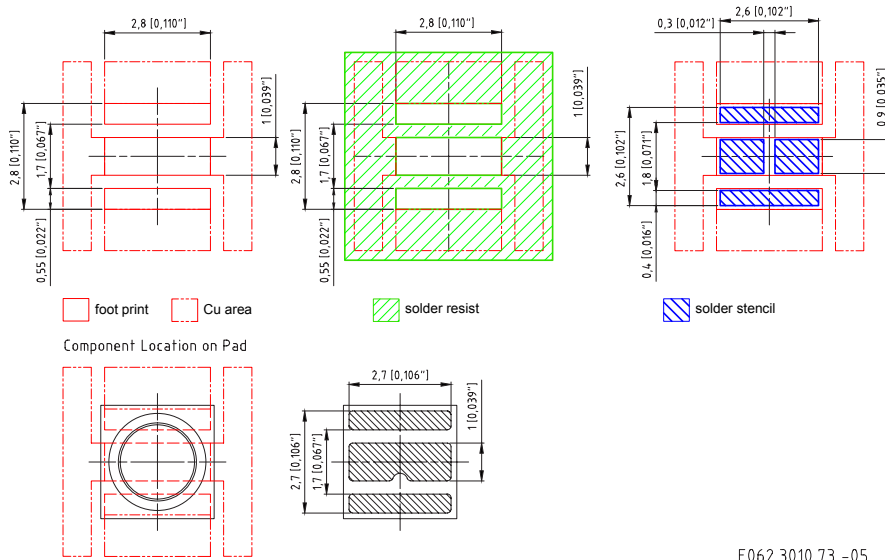
C67062-A0026-A5-02

Further Information:

Approximate Weight: 25.0 mg

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Recommended Solder Pad <sup>9)</sup>

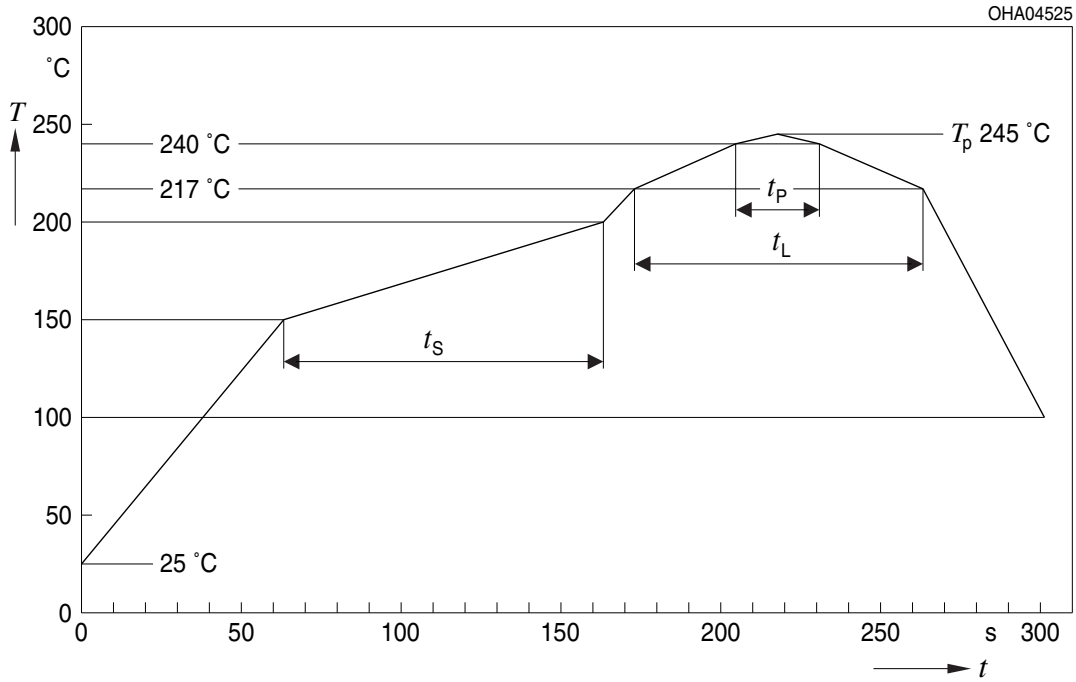


E062.3010.73 -05

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Further information can be found in our Application Note: "Handling and Processing Details for Ceramic LEDs".

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

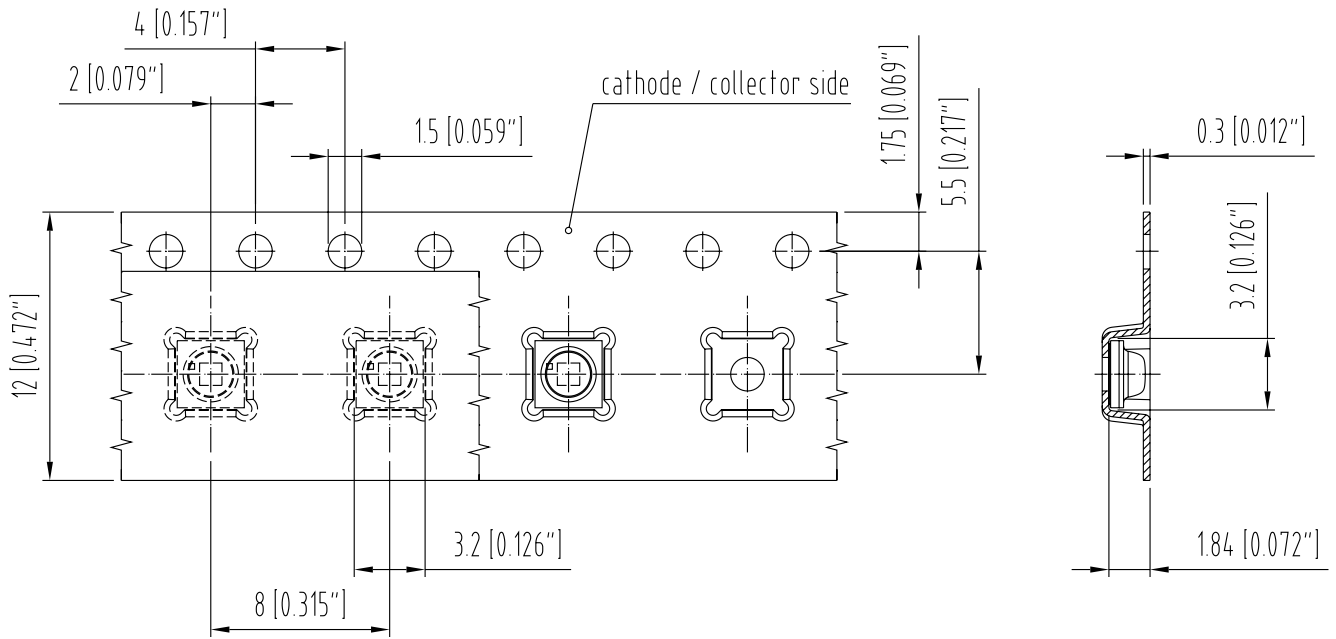


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak <sup>*)</sup> $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

All temperatures refer to the center of the package, measured on the top of the component

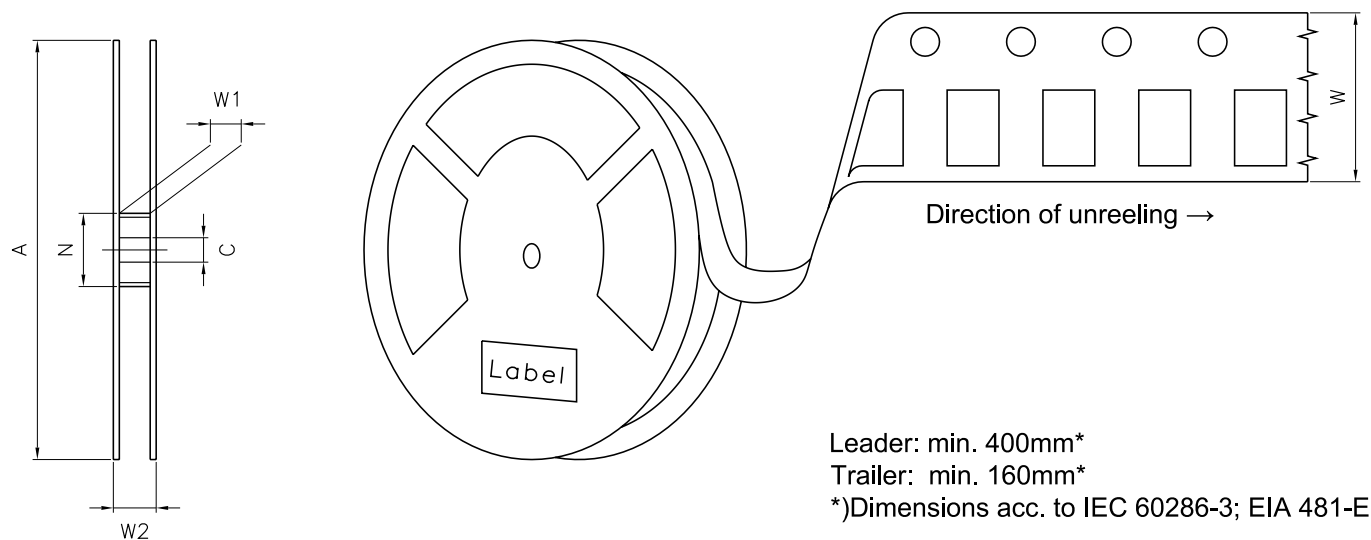
\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

Taping <sup>9)</sup>



C63062-A4051-B6 -04

## Tape and Reel <sup>10)</sup>



## Reel Dimensions

A	W	$N_{\min}$	$W_1$	$W_{2\max}$	Pieces per PU
180 mm	$12 + 0.3 / - 0.1$ mm	60 mm	$12.4 + 2$ mm	18.4 mm	600

### Barcode-Product-Label (BPL)

**OSRAM** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

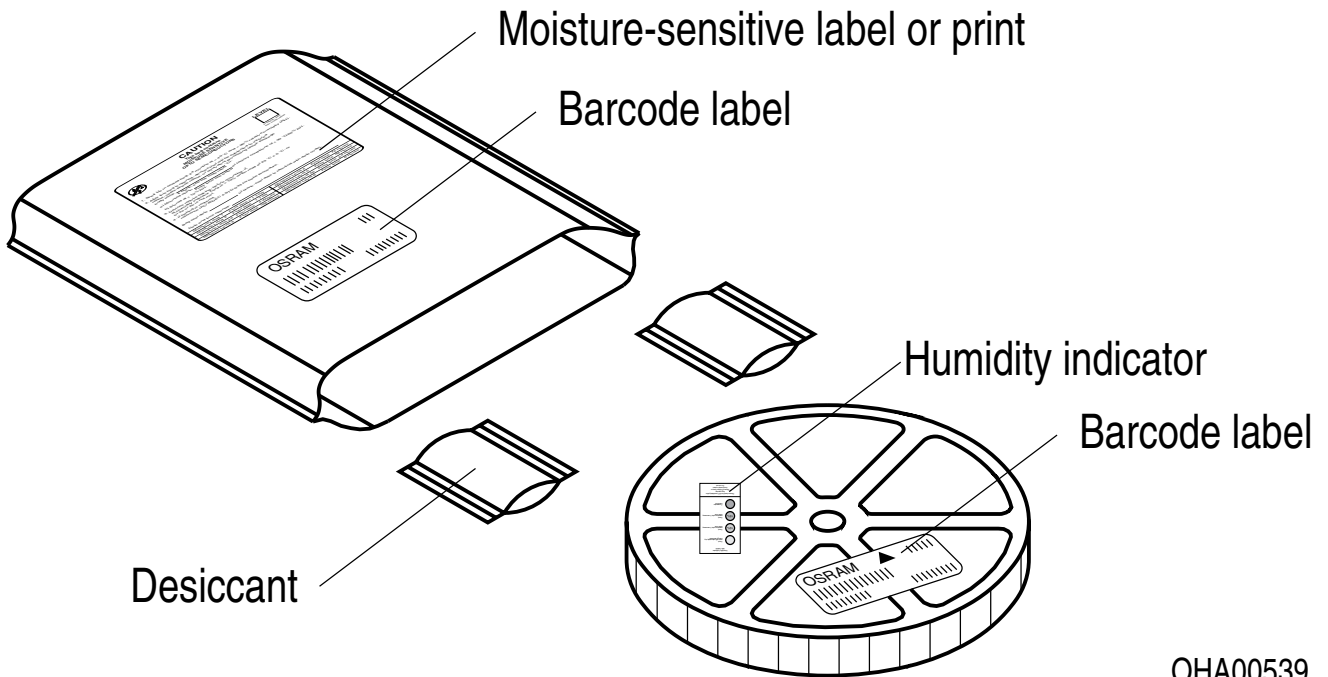
(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

ML Temp ST  
X XXX °C X

Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

OHA04563

### Dry Packing Process and Materials <sup>9)</sup>



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

---

## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

This device is designed for specific/recommended applications only. Please consult OSRAM Opto Semiconductors Sales Staff in advance for detailed information on other non-recommended applications (e.g. automotive).

Change management for this component is aligned with the requirements of the lighting market.

For further application related information please visit <https://ams-osram.com/support/application-notes>

## Disclaimer

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

---

## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 10 ms, with a tolerance of +/- 7%.
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Forward Voltage:** The Forward voltage is measured during a current pulse duration of typically 1 ms with a tolerance of  $\pm 0.05V$ .
- 4) **Color reproduction index:** Color reproduction index values (CRI-RA) are measured during a current pulse of typically 10 ms and with a tolerance of  $\pm 2$ .
- 5) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Thermal Resistance:**  $R_{th\ max}$  is based on statistic values ( $6\sigma$ ) used for Derating.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

---

## Revision History

Version	Date	Change
1.5	2020-02-28	Schematic Transportation Box Dimensions of Transportation Box
1.6	2021-06-18	Features Ordering Information Electro - Optical Characteristics (Diagrams) Chromaticity Coordinate Groups
1.7	2023-07-20	New Layout Applications

---



EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，  
不含有毒有害物质或元素。

**Published by ams-OSRAM AG**

Tobelbader Strasse 30, 8141 Premstaetten, Austria

Phone +43 3136 500-0

[ams-osram.com](http://ams-osram.com)

© All rights reserved

**am** 

**OSRAM**

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- ⊖ [View GW CSHPM1.CM-KTLP-XX57-1-350-R18 on WIN SOURCE](#)
- ⊖ [OSRAM Opto Semiconductors Inc. Information](#)

## Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management